



100V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(on)} Max	I _D Max T _A = +25°C
100V	$32m\Omega$ @ $V_{GS} = 10V$	5A
	49mΩ @ V _{GS} = 4.5V	4A

Features and Benefits

- High Conversion Efficiency
- Low R_{DS(on)}—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- 100% Unclamped Inductive Switching (UIS) Test in Production -Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(on)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

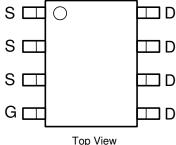
- High Frequency Switching
- Synchronous Rectification
- DC-DC Converters

Mechanical Data

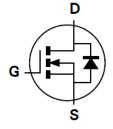
- Package: SO-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Finish—Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (Approximate)



Top View



Top View Pin Configuration



Equivalent Circuit

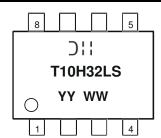
Ordering Information (Note 4)

Part Number	Bookens	Packing		
Part Number	Package	Qty.	Carrier	
DMT10H032LSS-13	SO-8	2500	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



⊃¦¦ = Manufacturer's Marking T10H32LS = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Year (ex: 21 = 2021) WW = Week (01 to 53)



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V _{DSS}	100	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	5 4	А
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)	I _{DM}	42	Α	
Maximum Continuous Body Diode Forward Current (Note 6	I _S	25	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cyc	I _{SM}	42	Α	
Avalanche Current, L = 0.3mH	I _{AS}	13	Α	
Avalanche Energy, L = 0.3mH	E _{AS}	25.3	mJ	

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

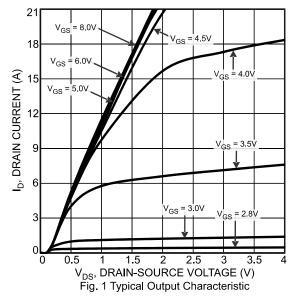
Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P _D	1.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	100	°C/W
Total Power Dissipation (Note 6)	P _D	1.9	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	60	°C/W
Thermal Resistance, Junction to Case (Note 6)	R _{OJC}	11	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)						•	
Gate Threshold Voltage	V _{GS(th)}	1.3	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Ctatic Duain Course On Desigtance		_	23	32	0	V _{GS} = 10V, I _D = 10A	
Static Drain-Source On-Resistance	R _{DS(on)}	_	34	49	mΩ	V _{GS} = 4.5V, I _D = 6A	
Diode Forward Voltage	V _{SD}	_	0.8	1.0	V	$V_{GS} = 0V, I_{S} = 6A$	
DYNAMIC CHARACTERISTICS (Note 8)		•	•	•		•	
Input Capacitance	C _{iss}	_	683	_	рF		
Output Capacitance	Coss	_	165	_	pF	$V_{DS} = 50V, V_{GS} = 0V,$ - f = 1MHz	
Reverse Transfer Capacitance	C_{rss}	_	6.9	_	pF	T = IMHZ	
Gate Resistance	R_g	_	1.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	6.3	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qq	_	11.9	_	nC	V _{DS} = 50V, I _D = 6A	
Gate-Source Charge	Q _{gs}	_	2.0	_	nC		
Gate-Drain Charge	Q_{gd}	_	3.1	_	nC		
Turn-On Delay Time	t _{D(on)}	_	4.1	_	ns		
Turn-On Rise Time	t _R	_	4.5	_	ns	$V_{DS} = 50V, R_{L} = 5.85\Omega$	
Turn-Off Delay Time	t _{D(off)}	_	12.5	_	ns	$V_{GS} = 10V, R_{GEN} = 3\Omega$	
Turn-Off Fall Time	t _F	_	9.3	_	ns		
Reverse Recovery Time	t _{RR}	_	31.5	_	ns		
Reverse Recovery Charge	Q _{RR}	_	94.6	_	nC	I _F = 6A, di/dt = 500A/µs	

- Device mounted on FR-4 substrate PCB, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PCB, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.





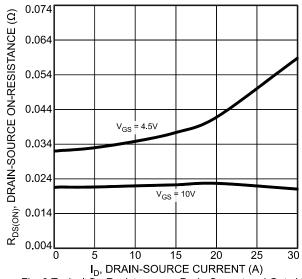


Fig. 3 Typical On-Resistance vs. Drain Current and Gate Voltage

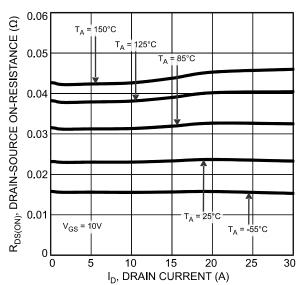
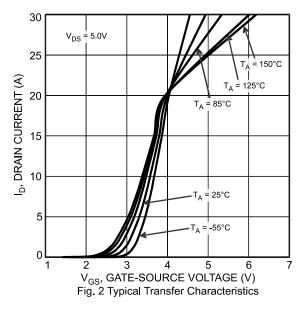


Fig. 5 Typical On-Resistance vs. Drain Current and Junction Temperature



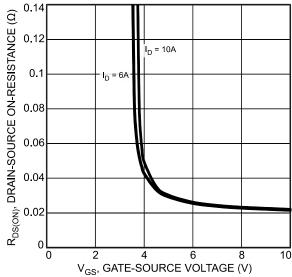


Fig. 4 Typical Drain-Source On-Resistance vs. Gate-Source Voltage

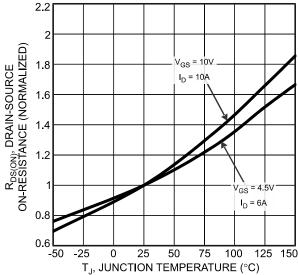


Fig. 6 On-Resistance Variation with Junction Temperature



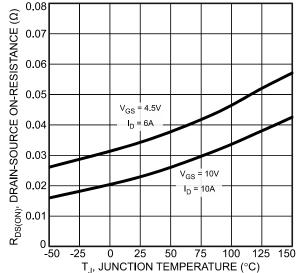
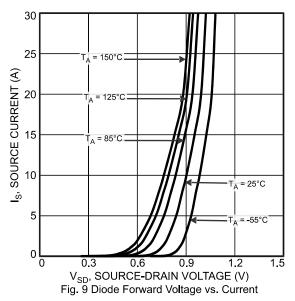
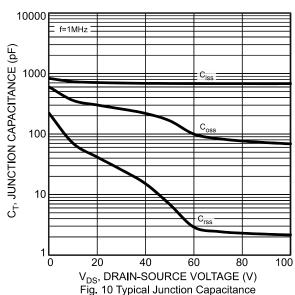


Fig. 7 On-Resistance Variation with Junction Temperature





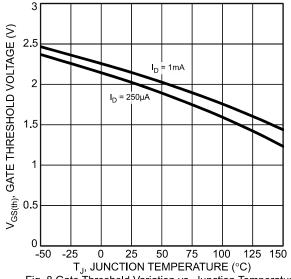


Fig. 8 Gate Threshold Variation vs. Junction Temperature

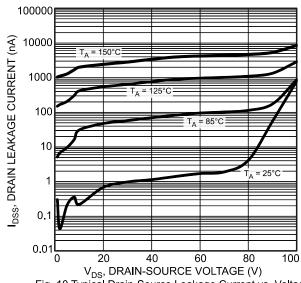
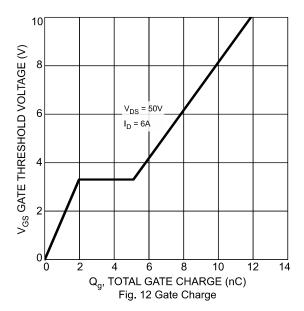
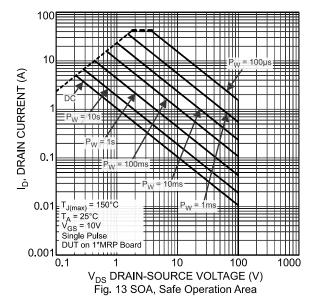
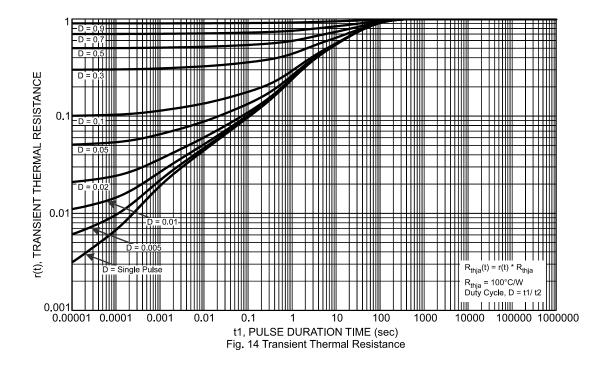


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage





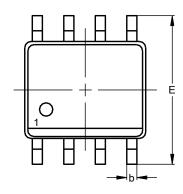


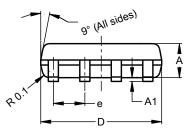


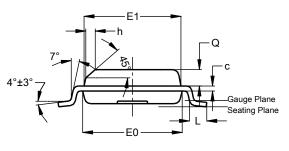


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.







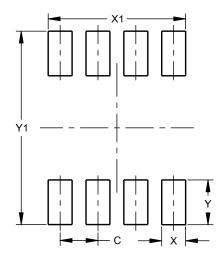
SO-8

SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h			0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
V1	6.50



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